

09-18-1998

Form PTO-1595
1-31/92



HEET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

100832562

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof

1. Name of Conveying Part(ies):
Doug David

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):

Name: Micron Technology, Inc.

Internal Address:

Street Address: 8000 South Federal Way

City: Boise State: ID Zip: 83706

Additional names(s) & address(es) attached: Yes No

j-c-542 U.S. PTD
 09/145492
 09/11/98

3. Nature of conveyance:

Assignment Security Agreement
 Merger Change of Name
 Other _____

Execution Date: 08/28/98

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: 08/28/98

A. Patent Application No.(s):

Additional numbers attached: Yes No

B. Patent No.(s)

Additional numbers attached: Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Lance R. Sadler

Internal Address: Wells, St. John, Roberts,
Gregory & Matkin P.S.

Street Address: 601 W. First Avenue, Ste. 1300

City: Spokane State: WA Zip: 99201-3828

6. Total number of applications and patents involved. 1

7. Total fee (37 CFR 3.41). \$ 40
 Enclosed
 Authorized to be charged to deposit account

8. Deposit account number
23-0925

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and Signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Lance R. Sadler
Name of Person Signing

Signature

9/1/98
Date

TOTAL NUMBER OF PAGES INCLUDING COVER SHEET, ATTACHMENTS AND DOCUMENT: 5

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1 PATENT ASSIGNMENT

2 PARTIES TO THE ASSIGNMENT:

3 INVENTOR:

4 Doug David

5

6 ASSIGNEE:

7 Micron Technology, Inc.
8 Corporation of the State of Delaware
9 8000 South Federal Way
10 Boise, Idaho 83706-9632

11 BACKGROUND OF THIS ASSIGNMENT:

12 INVENTOR has conceived certain new and useful inventions
13 disclosed in a United States patent application titled Semiconductor
14 Wafer Alignment Methods and Semiconductor Wafer Alignment Tools.

15 MICRON TECHNOLOGY, INC. desires to acquire the entire right,
16 title and interest in said inventions and with respect to any Letters
17 Patent that may be granted with respect to the inventions in both the
18 United States and in all foreign countries.

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1 **THE PARTIES AGREE AS FOLLOWS:**

2 In consideration of good and valuable consideration, the receipt
3 sufficiency and adequacy of which is hereby acknowledged, INVENTOR
4 hereby sells, assigns and transfers to MICRON TECHNOLOGY, INC.
5 the entire right and interest in the above-identified application executed
6 concurrently with this assignment and to any reissues, renewals, divisions
7 or continuations thereof, and hereby authorizes the Commissioner of
8 Patents and Trademarks to issue such Letters Patent to MICRON
9 TECHNOLOGY, INC. for the sole use of MICRON TECHNOLOGY,
10 INC., its successors or assigns.

11 INVENTOR further agrees to execute, at the request and expense
12 of MICRON TECHNOLOGY, INC. such other formal documents as may
13 be required to fully convey the interest transferred herein and will
14 similarly execute any application papers required for the filing of any
15 division, continuation, renewal or reissue of the patent application or
16 resulting Letters Patent; and will generally do everything necessary or
17 desirable to obtain and enforce proper protection for the invention
18 assigned hereby.

19 INVENTOR further assigns to MICRON TECHNOLOGY, INC. the
20 whole right, title and interest in the inventions disclosed in the
21 application throughout all countries foreign to the United States.
22 MICRON TECHNOLOGY, INC. is hereby authorized to apply for
23 patents relating to the inventions in its own name in countries where
24 such procedure is proper; to claim the benefit of the International

1 Convention; to file and prosecute International Applications relating to
2 the inventions under the Patent Cooperation Treaty; and to file and
3 prosecute applications relating to the inventions under the European
4 Patent Convention. INVENTOR agrees to execute applications relating
5 to the inventions in those countries and under those conventions where
6 it is necessary that the same be executed by the inventor, and to
7 execute assignments of such applications and the resulting Letters Patent
8 to MICRON TECHNOLOGY, INC. as well as all other necessary papers
9 in relation to such applications and Letters Patent.

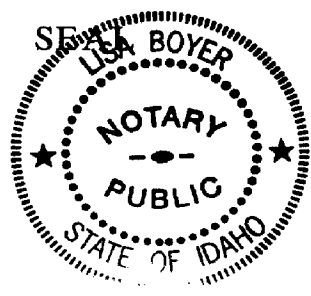
10 INVENTOR further warrants and covenants that no assignment,
11 grant, mortgage, license or other agreement affecting the rights and
12 property herein conveyed has been or will be made to others by the
13 undersigned, and that the full rights to convey the same as herein
14 expressed is possessed by the undersigned.

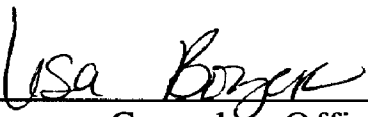
1 To be binding on the heirs, assigns, representatives and successors
2 of the undersigned and extend to the successors, assigns and nominees
3 of the Assignees.

4
5 (Signature)  Date: 8-28-98
6 Doug David

7 State of Idaho)
8 County of Ada) ss.

9 BEFORE ME, this 28 day of August 1998
10 personally appeared the above-named inventor, to me known to be the
11 person who is described in and who executed the foregoing assignment
instrument and acknowledged to me that he/she executed the same of
his/her own free will for the purpose therein expressed.



12
13 
14 Notary or Consular Officer
15 My Commission Expires: 1-9-2002